Ceramic Resonator SMD 4.5 x 2.0mm

MRCR series

MERITEK

FEATURE

- Built-In Capacitor Option
- High Reliability Low Cost
- RoHS Compliant



PART NUMBERING SYSTEM

 $\frac{MRCR}{(1)}$ $\frac{T}{(2)}$ $\frac{5}{(3)}$ $\frac{6M0}{(4)}$



No	Item	Code	Description	Series Reference	
(1)	Meritek Series	MRCR	Resonator Unit	SMD Ceramic Resonator 4.5 x 2.0mm	
(2)	Built-In Capacitor	Т	T: 3 Pad	T: 3 Pad (with built-in capacitor), A: 2 Pad (without)	
(3)	Frequency Accuracy	5	5: ±0.5% (standard)	5: ±0.5% (standard), 3: ±0.3%	
(4)	Frequency	6M0	6M0: 6.00MHz	4M0 ~ 8M0 (M denotes decimal point)	

Notes:

- 1. See table below for Standard Built-In Capacitance Values. Contact Meritek for more info regarding non-standard Built-In Capacitance.
- 2. Contact Meritek for information regarding custom options.

ELECTRICAL CHARACTERISTICS

Para	meters	Characteristic	
Frequency Range		4.00 ~ 8.00 MHz	
Resonant Impedance	4.00 ~ 8.00 MHz	40 Ω max.	
Frequency Accurancy		±0.5% (±0.3% optional)	
Temp Coefficient (-25°C ~ +85°C)	4.00 ~ 8.00 MHz	±0.4%	
Operating Temperature		-25 ~ +85°C	
Storage Temperature		-55 ~ +85°C	
Withstanding Voltage		50 Vdc max. (DC, 1 min.)	
Aging		±0.2% (from initial value)	
Insulation Resistance		500 MΩ min. (@10Vdc, 1 min)	
Dating Valtage		6Vdc	
Rating Voltage		15V p-p	
Packaging Unit		3,000 pcs (Tape and Reel)	

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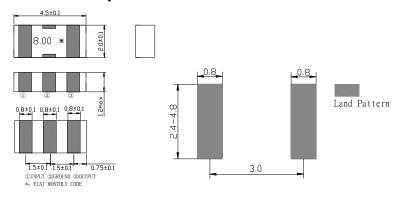
MRCR series

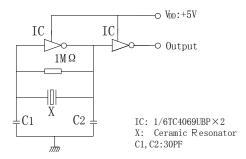
MERITEK

OUTLINE DRAWING AND TEST CIRCUIT

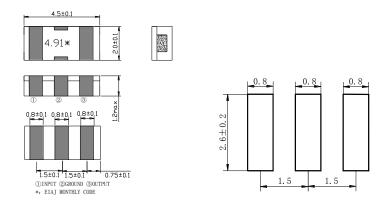
Test parts under the condition (Temp.: 20±15°C, Humidity: 65±20% R.H.) unless regulated measuring standard condition is (Temp.: 25±3°C, Humidity: 65±10% R.H.)

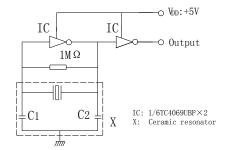
MRCRA: 2 Pad - Without Built-In Capacitance





MRCRT: 3 Pad - With Built-In Capacitance





Ceramic Resonator SMD 4.5 x 2.0mm



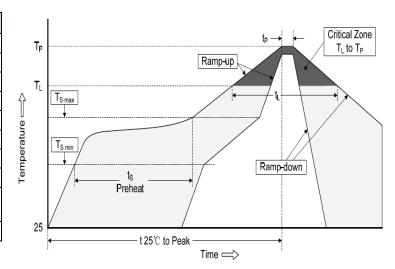
STANDARD BUILT-IN CAPACITANCE (C1=C2)

Frequency Range	C1=C2 Value	
4.00 ~ 8.00 MHz	15pF, 30pF, 33pF ±20%	

- 1. For 3 Pad Built-In Capacitance Resonators only.
- 2. Values can be used as reference for test ciruits of 2 Pad Resonators.

RECOMMENDED SOLDERING PROFILES

Reflow Condition					
	Temp. Min T _{s(min)}	140°C			
Pre Heat	Temp. Max T _{s(max)}	170°C			
11001	Time (min. to max.) (t _s)	80~120 seconds			
Average	ramp up rate (T∟) to peak	1°C/second max.			
T _{s(max)} to	T _∟ (Ramp-up rate)	3°C/second max.			
Reflow	Temp. (T _L)	230°C			
Kellow	Time (min. to max.) (t _L)	30~40 seconds			
Peak Tem	perature (T _P)	260°C			
Time with Temperat	nin 5°C of actual peak cure (t _p)	10 seconds max.			
Ramp-do	wn Rate	6°C/second			



CAUTION

- Do not apply excess mechanical stress to the components or terminals during soldering.
- Do not bend the component.
- This component is not hermetically sealed. Do not clean or wash the component.
- Do not use strong acidity flux with more than 0.2wt% of chlorine content during flow soldering.
- Keep component away from fire.
- Do not apply any type of re-flow soldering to the component.
- This document specifies the quality and performance of the component as a single unit. The application circuit may affect the performance. Evaluate thoroughly.
- Shelf Life of the component is 12 months after delivery. Keep components in sealed package. Meritek recommends that components stored longer than six months are tested for solderability before use.
- This product is not recommended for Automotive, Medical or Life Critical applications. Contact Meritek to learn more about components for such applications.

^{*}Specifications subject to change without notice.